



Min

4.03

6.40

1.10

5.01

4.37

.71

.36

1.73

3A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

POWERMITE[®]3

Max

4.09

6.61

1.14

5.17

4.43

.77

.46

1.83

.889 NOM

1.83 NOM

.178 NOM

.178 NOM

Features

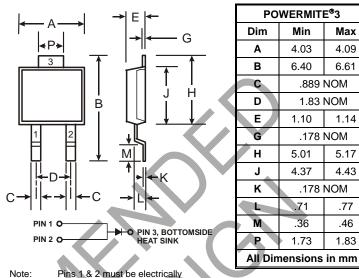
- Guard Ring Die Construction for Transient Protection •
- Low Power Loss, High Efficiency •
- Low Reverse Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant Version (Note 2)

Mechanical Data

- Case: POWERMITE®3 •
- Case Material: Molded Plastic: UL Flammability . Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish). @3
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3

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Weight: 0.072 grams (approximate)



Pins 1 & 2 must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Rectified Output Current (See also Figure 5)	lo	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load @ $T_{C} = 25^{\circ}C$ @ $T_{C} = 100^{\circ}C$	IFSM	100 50	A
Typical Thermal Resistance Junction to Soldering Point	R _{0JS}	3.2	°C/W
Operating Temperature Range	Tj	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

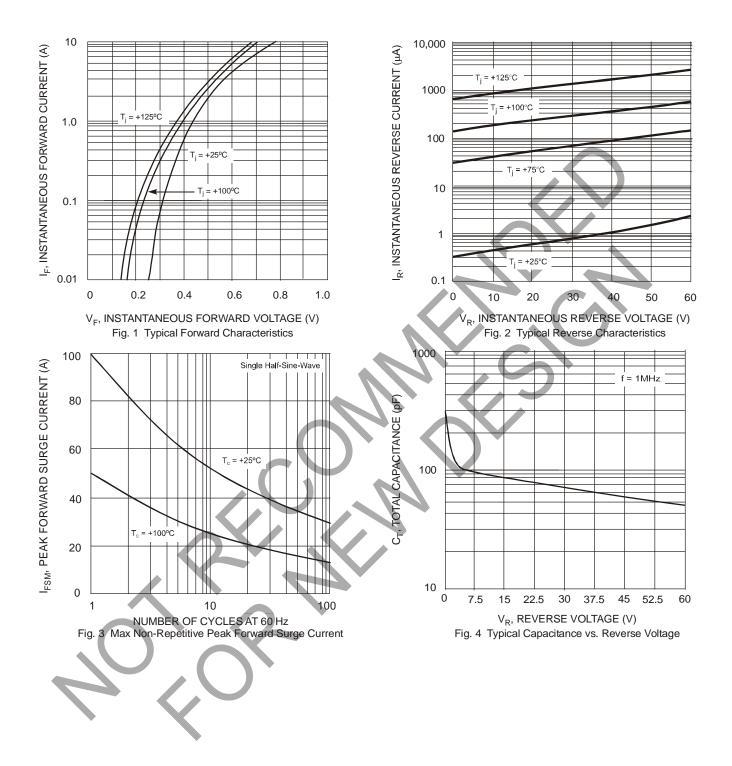
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	60	_		V	$I_R = 0.2mA$
Forward Voltage	Vfm		0.59 0.53 0.72 0.63	0.63 0.57 0.76 0.67	V	$ \begin{split} I_F &= 3A, \ T_j = \ 25^\circ C \\ I_F &= 3A, \ T_j = \ 125^\circ C \\ I_F &= 6A, \ T_j = \ 25^\circ C \\ I_F &= 6A, \ T_j = \ 125^\circ C \end{split} $
Reverse Current (Note 1)	I _{RM}		2.0 0.6 2.5	200 20 150	μA mA mA	$ \begin{array}{l} T_{j} = \ 25^{\circ}\text{C}, \ V_{R} = 60\text{V} \\ T_{j} = 100^{\circ}\text{C}, \ V_{R} = 60\text{V} \\ T_{j} = 125^{\circ}\text{C}, \ V_{R} = 60\text{V} \end{array} $
Total Capacitance	CT	—	130		pF	$f = 1.0MHz, V_R = 4.0V DC$

Notes: 1. Short duration pulse test used to minimize self-heating effect.

2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

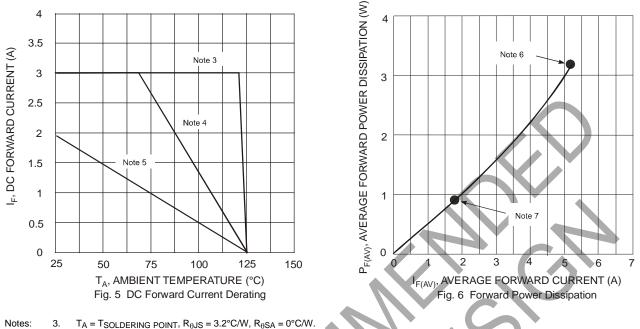


NOT RECOMMENDED FOR NEW DESIGN USE PDS360





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- 3. 4. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{0JA} in range of 20-40°C/W.
 - Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout 5. document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R_{0JA} in range of 100-120°C/W.
 - Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 5. 6.
 - 7.

Ordering Information (Note 8)

Device	Packaging	Shipping
MBRM360-13-F	POWERMITE [®] 3	5000/Tape & Reel

8. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. Notes:

Marking Information



MBRM360 = Product type marking code
 Miskinstol = Product type marking code

 J1: = Manufacturers' code marking

 YYWW = Date code marking

 YY = Last digit of year (ex: 02 for 2002)

 WW = Week code (01 to 53)

 (K) = Factory Designator



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